UNISONIC TECHNOLOGIES CO., LTD

2NM70-Q Preliminary Power MOSFET

2A, 700V N-CHANNEL SUPER-JUNCTION MOSFET

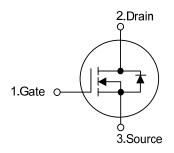
DESCRIPTION

The **UTC 2NM70-Q** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

■ FEATURES

- * $R_{DS(ON)}$ < 3.3 Ω @ V_{GS} = 10V, I_{D} =1.0A
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

■ SYMBOL

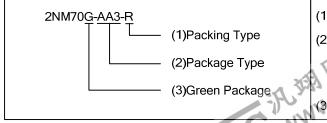


1 TO-220F1 TO-220F2 TO-252

■ ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking
Lead Free	Halogen Free	Package	1	2	3	Packing
-	2NM70G-AA3-R	SOT-223	G	D	S	Tape Reel
2NM70L-TA3-T	2NM70G-TA3-T	TO-220	G	D	S	Tube
2NM70L-TF1-T	2NM70G-TF1-T	TO-220F1	G	D	S	Tube
2NM70L-TF2-T	2NM70G-TF2-T	TO-220F2	G	D	S	Tube
2NM70L-TF3-T	2NM70G-TF3-T	TO-220F	G	D	S	Tube
2NM70L-TM3-R	2NM70G-TM3-R	TO-251	G	D	S	Tape Reel
2NM70L-TN3-R	2NM70G-TN3-R	TO-252	252 G D S T		Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



- (1) T: Tube, R: Tape Reel
- (2) AA3: SOT-223, TA3: TO-220, TF3: TO-220F,
 - TF1: TO-220F1, TF2: TO-220F2, TM3: TO-251,
 - TN3: TO-252
- (3) L: Lead Free, G: Halogen Free and Lead Free

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MARKING

SOT-223	TO-220 / TO-220F / TO-220F1 TO-220F2 / TO-251 / TO-252			
2NM70G Lot Code	UTC 2NM70 L: Lead Free G: Halogen Free Lot Code 1			



ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	700	V
Gate-Source Voltage		V _{GSS}	±30	V
Duncin Course at	Continuous	I _D	700 ±30 2.0 8.0 1.0 69 4.7 V 10 45 28 40 30 +150	А
Drain Current	Pulsed (Note 2)	I _{DM}	8.0	А
Avalanche Current (No	te 2)	I _{AR}	1.0	А
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	69	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.7	V/ns
	SOT-223		10	W
	TO-220		45	W
Power Dissipation	TO-220F/TO-220F1	P _D	28	W
	TO-220F2		40	W
	TO-251/TO-252		30	W
Junction Temperature		TJ	+150	°C
Operating Temperature	Э	T _{OPR}	-55 ~ +150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by T_J.
- 3. L=138mH, I_{AS} =1.0A, V_{DD} =50V, R_{G} =25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD}\leq 2.0A$, di/dt $\leq 200A/\mu s$, $V_{DD}\leq BV_{DSS}$, Starting T_J = 25°C

THERMAL DATA

PARA	METER	SYMBOL	RATINGS	UNIT
	SOT-223		150	°C/W
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2	θ_{JA}	62.5	°C/W
	TO-251/TO-252		110	°C/W
	SOT-223		12.5	°C/W
	TO-220		2.76	°C/W
Junction to Case	TO-220F/TO-220F1	θ _{JC}	4.46	°C/W
	TO-220F2	O-220F1/TO-220F2 O-251/TO-252 O-251/TO-252 O-223 O-220 O-220F/TO-220F1 O-220F/TO-220F1 O-220F2 O-220F	°C/W	
	TO-251/TO-252		4.17	°C/W



ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

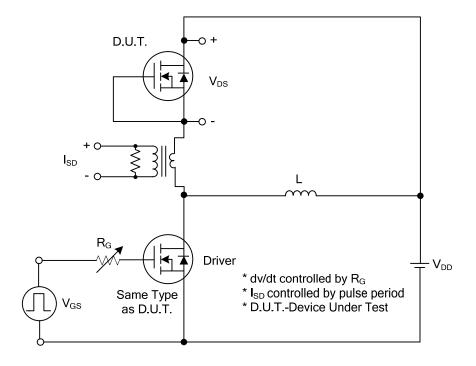
PARAMETER		SYMBOL	TEST CONDITIONS		TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	700			V
Drain-Source Leakage Current		I_{DSS}	$V_{DS} = 700V, V_{GS} = 0V$			10	μΑ
Gate-Source Leakage Current	Forward	orward	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
	Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.5	V
Static Drain-Source On-State Res	sistance	R _{DS(ON)}	$V_{GS} = 10V, I_D = 1.0A$			3.3	Ω
DYNAMIC CHARACTERISTICS		_				-	
Input Capacitance		C_{ISS}			125		pF
Output Capacitance	Output Capacitance		V _{DS} =25V, V _{GS} =0V, f =1MHz		85		pF
Reverse Transfer Capacitance		C_{RSS}			10		pF
SWITCHING CHARACTERISTIC	S	_				-	
Total Gate Charge		Q_{G}	V _{DS} =50V, V _{GS} =10V, I _D =1.3A I _G =100μA (Note 1, 2)		23		nC
Gate-Source Charge		Q_GS			2.5		nC
Gate-Drain Charge		Q_GD	IG-100µA (Note 1, 2)		6		nC
Turn-On Delay Time		t _{D (ON)}			35		ns
Turn-On Rise Time		t_R	V_{DD} =30V, V_{GS} =10V, I_{D} =0.5A,		24		ns
Turn-Off Delay Time		t _{D(OFF)}	$R_G = 25\Omega$ (Note 1, 2)		73		ns
Turn-Off Fall Time		t_{F}] [53		ns
DRAIN-SOURCE DIODE CHARA	CTERISTIC	CS					
Continuous Drain-Source Current		I _S				2.0	Α
Maximum Pulsed Drain-Source Diode						8.0	Α
Forward Current		I _{SM}				0.0	А
Drain-Source Diode Forward Voltage		V_{SD}	I _S =2.0A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Ti	me	t_{RR}	I _S =2.0A, V _{GS} =0V		240		nS
Body Diode Reverse Recovery Charge		Q_{RR}	dI/dt=100A/μs		1.15		μC

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle≤2%.

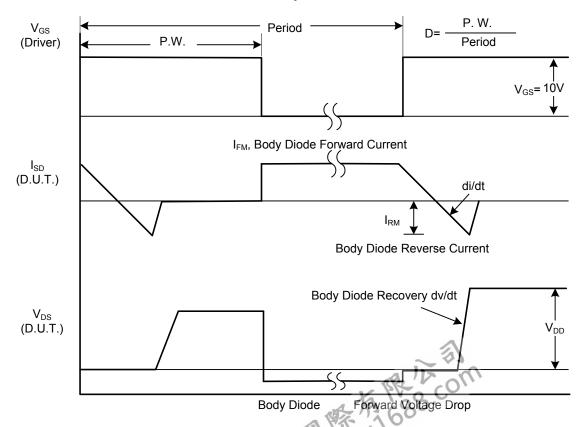


^{2.} Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

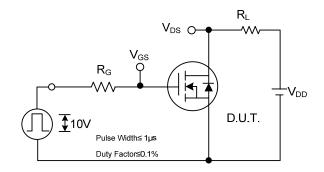


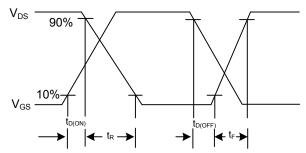
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

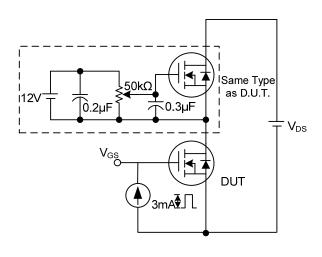
TEST CIRCUITS AND WAVEFORMS (Cont.)

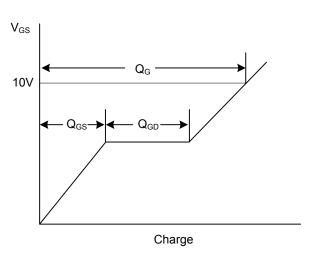




Switching Test Circuit

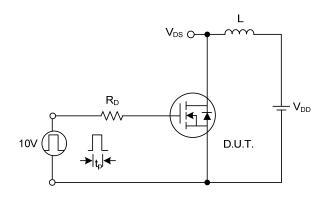
Switching Waveforms

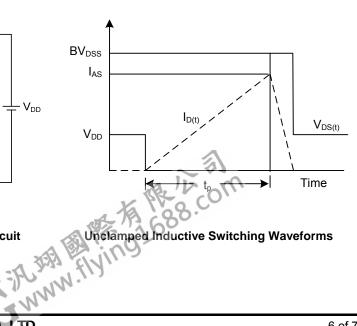




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

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